

L Number	Hits	Search Text	DB	Time stamp
-	224	(257/348).CCLS.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/10/13 08:19
-	451	(257/349).CCLS.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/10/13 09:01
-	1009	(257/350).CCLS.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/10/13 11:44
-	8757	substrate and adhesive and resin and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/10/13 15:44
-	7	("5901050" "6097089" "6132543" "6168859" "6249051" "6376100" "6437450").PN.	USPAT	2004/10/13 14:59
-	2691	shielding and transistors and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/10/13 16:05
-	1228	(257/734).CCLS.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/10/13 16:15
-	31	wl-csp	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/10/13 16:07
-	146	257/734 and heat adj sink	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/10/13 18:26